L Number	Hits	Search Text	DB	Time stamp
1	9	core same (AlOx or "aluminum oxide") same	USPAT;	2004/08/31 13:23
		(Al or aluminum) same (Cu or copper) same	US-PGPUB;	
		adhesive	EPO; JPO;	
			DERWENT; IBM TDB	
2	1351	core and (AlOx or "aluminum oxide") and	USPAT;	2004/08/31 15:45
-	1331	(Al or aluminum) and (Cu or copper) and	US-PGPUB;	2004/00/31 13:43
		(adhesive or bond\$3) and laminat\$3	EPO; JPO;	
			DERWENT;	
			IBM TDB	
3	5581	core and (AlOx or "aluminum oxide") and	USPAT;	.2004/08/31 13:34
		(Al or aluminum) and (Cu or copper)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	0.45	(220 # 2 *	IBM_TDB	0004400400
4	245		USPAT;	2004/08/31 14:01
		(Al or aluminum) same (Cu or copper)	US-PGPUB;	
			EPO; JPO; DERWENT;	
	1		IBM TDB	
5	104	core and (AlOx or "aluminum oxide") and	USPAT;	2004/08/31 15:59
1		(Al or aluminum) and (Cu or copper) and	US-PGPUB;	
		(LCP or "liquid crystal polymer")	EPO; JPO;	
			DERWENT;	
1_	_		IBM_TDB	
6	2	6328201.pn.	USPAT;	2004/08/31 14:08
			US-PGPUB;	
			EPO; JPO;	
			DERWENT; IBM TDB	
8	1		USPAT	2004/08/31 14:11
10			USPAT	2004/08/31 14:13
11	53	(PCB or "printed circuit board") and (AlOx	USPAT;	2004/08/31 14:17
		or "aluminum oxide") and (Al or aluminum)	US-PGPUB;	
		and (Cu or copper) and (LCP or "liquid	EPO; JPO;	
		crystal polymer")	DERWENT;	
12	1278	(DCD on Unwinted singuity beauty) and (D10)	IBM_TDB	0004/00/21 14 10
12	12/0	(PCB or "printed circuit board") and (AlOx or "aluminum oxide") and (Al or aluminum)	USPAT; EPO; JPO;	2004/08/31 14:18
		and (Cu or copper)	DERWENT;	
		( 01 00ppo1)	IBM TDB	
13	612	(PCB or "printed circuit board") and (AlOx	USPAT;	2004/08/31 15:45
		or "aluminum oxide") and (Al or aluminum)	EPO; JPO;	
. *	·	and (Cu or copper) and adhesive	DERWENT;	
1			IBM_TDB	
15	1099	core and (AlOx or "aluminum oxide") and	USPAT;	2004/08/31 15:46
	14. 1	(Al or aluminum) and (Cu or copper) and	US-PGPUB;	
		(adhesive or bond\$3 or paste) and (laminated or lamination)	EPO; JPO; DERWENT;	
			IBM TDB	
17	12649	laminating same (temperature or degree)	USPAT;	2004/08/31 15:52
			EPO; JPO;	
			DERWENT;	
	_		IBM_TDB	
18	87	(core and (AlOx or "aluminum oxide") and	USPAT;	2004/08/31 15:52
		(Al or aluminum) and (Cu or copper) and	EPO; JPO;	
		(adhesive or bond\$3 or paste) and (laminated or lamination) ) and	DERWENT;	
		(laminated or lamination) ) and (laminating same (temperature or degree))	IBM_TDB	
19	53	adhesive same dielectric same (LCP or	USPAT;	2004/08/31 16:00
1		"liquid crystal polymer")	US-PGPUB;	=111, 30, 31 10,00
		_ · · ·	EPO; JPO;	
			DERWENT;	
			IBM_TDB	